



# UT3404

*Power MOSFET*

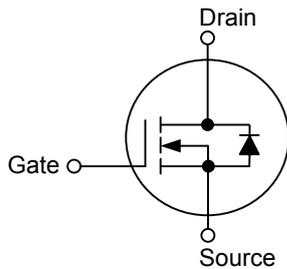
## N-CHANNEL ENHANCEMENT MODE MOSFET

■ DESCRIPTION

The **UT3404** is N-Channel enhancement mode power MOSFET, designed with high density cell, with fast switching speed, low on-resistance, excellent thermal and electrical capabilities and operation with low gate voltages.

This device is suitable for use as a load switch or in PWM applications.

■ SYMBOL

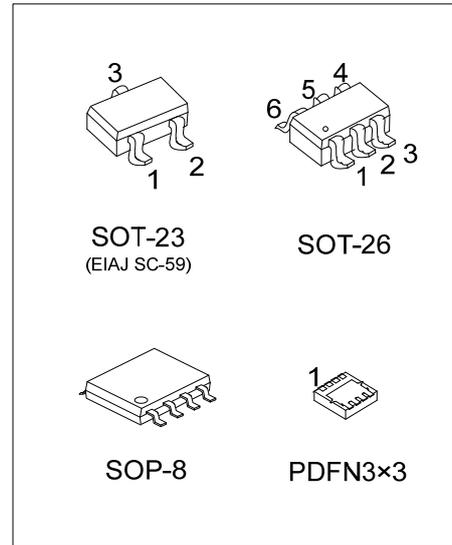


■ ORDERING INFORMATION

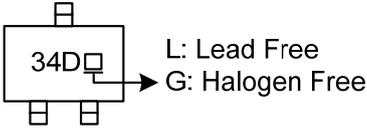
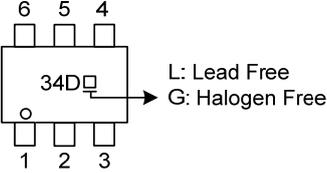
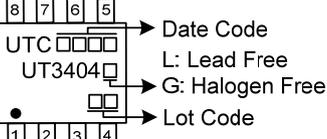
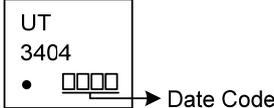
Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT3404L-AE2-R	UT3404G-AE2-R	SOT-23-3	G	S	D	-	-	-	-	-	Tape Reel
UT3404L-AE3-R	UT3404G-AE3-R	SOT-23	G	S	D	-	-	-	-	-	Tape Reel
UT3404L-AG6-R	UT3404G-AG6-R	SOT-26	D	D	G	S	D	D	-	-	Tape Reel
UT3404L-S08-R	UT3404G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UT3404L-P3030-R	UT3404G-P3030-R	PDFN3×3	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate S: Source D: Drain

<p>UT3404G-AE2-R</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) R: Tape Reel (2) AE2: SOT-23-3, AE3: SOT-23, AG6: SOT-26 S08: SOP-8, P3030: PDFN3×3 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING

SOT-23-3 / SOT-23	SOT-26
 <p>34D □ → L: Lead Free G: Halogen Free</p>	 <p>34D □ → L: Lead Free G: Halogen Free</p>
SOP-8	PDFN3x3
 <p>UTC □ □ □ □ → Date Code L: Lead Free UT3404 □ → G: Halogen Free □ □ □ □ → Lot Code</p>	 <p>UT 3404 • □ □ □ □ → Date Code</p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_A=25^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	30	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Continuous Drain Current		$I_D$	5.8	A
Pulsed Drain Current		$I_{DM}$	20	A
Power Dissipation	SOT-23-3/SOT-23	$P_D$	1.4	W
	SOT-26		1.6	W
	SOP-8		2	W
	PDFN3x3		18	W
Junction Temperature		$T_J$	+150	$^{\circ}\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^{\circ}\text{C}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-23-3/SOT-23	$\theta_{JA}$	85	$^{\circ}\text{C}/\text{W}$
	SOT-26		115	$^{\circ}\text{C}/\text{W}$
	SOP-8		62.5	$^{\circ}\text{C}/\text{W}$
	PDFN3x3		75	$^{\circ}\text{C}/\text{W}$
Junction to Case	PDFN3x3	$\theta_{JC}$	6.9	$^{\circ}\text{C}/\text{W}$

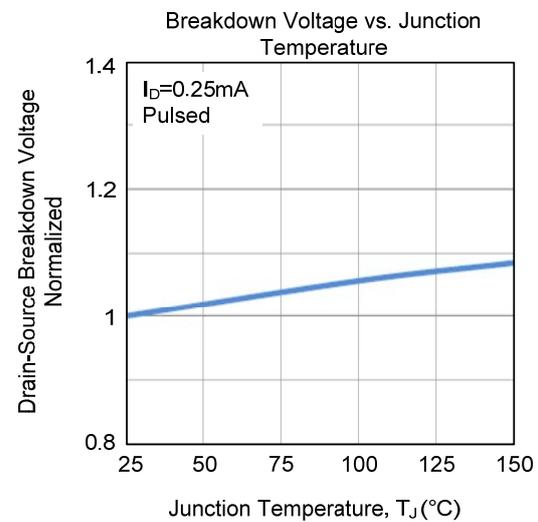
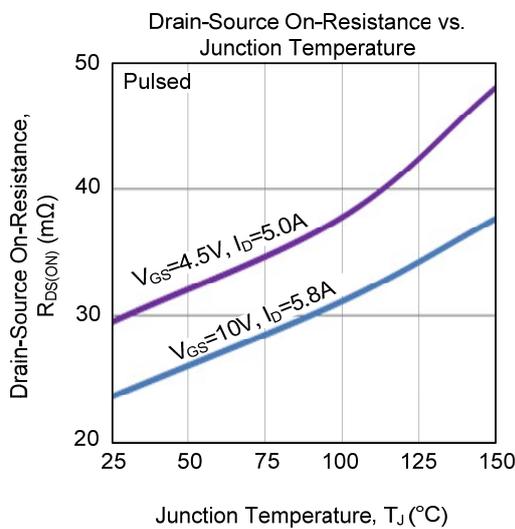
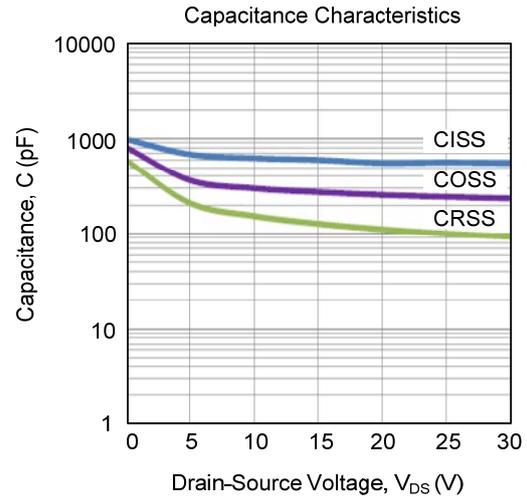
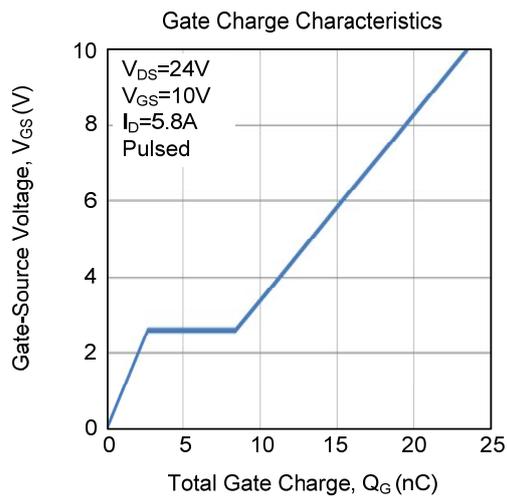
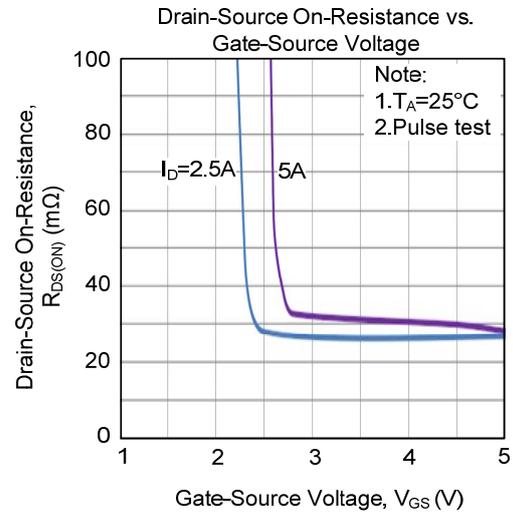
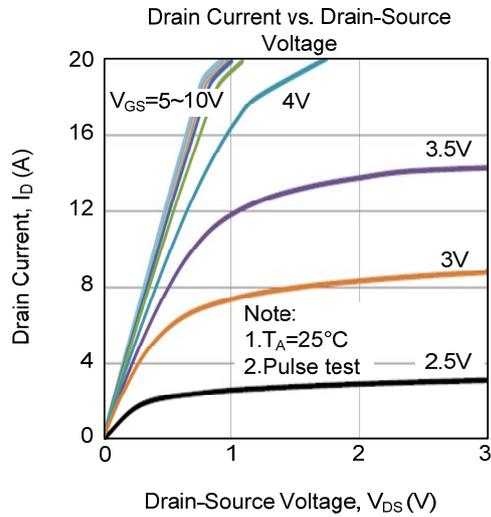
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

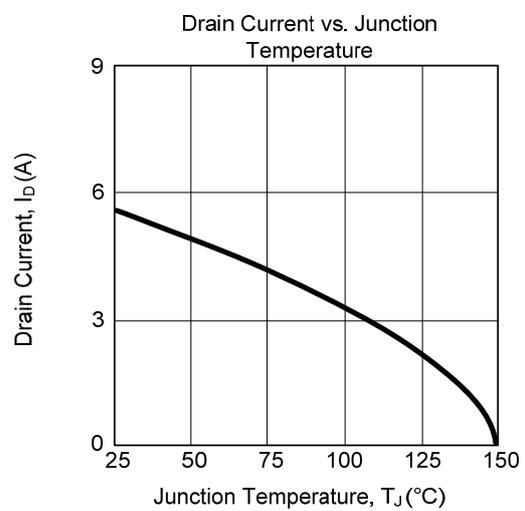
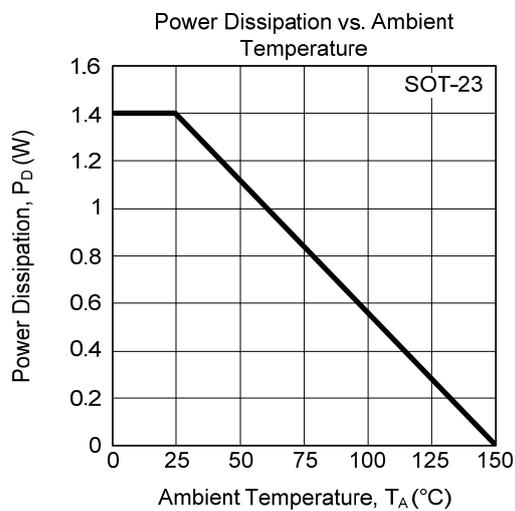
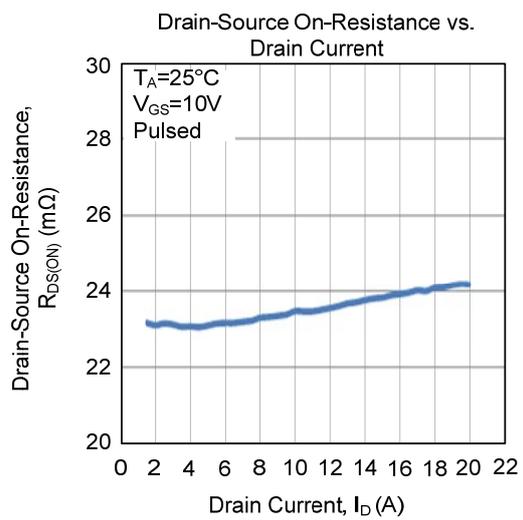
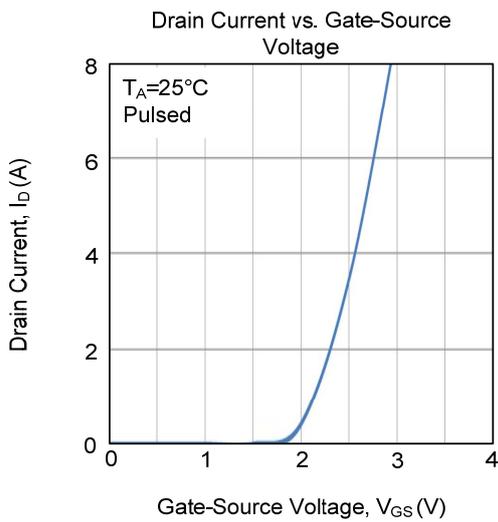
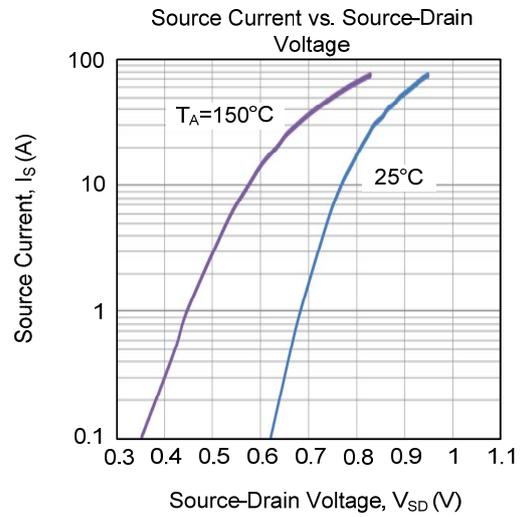
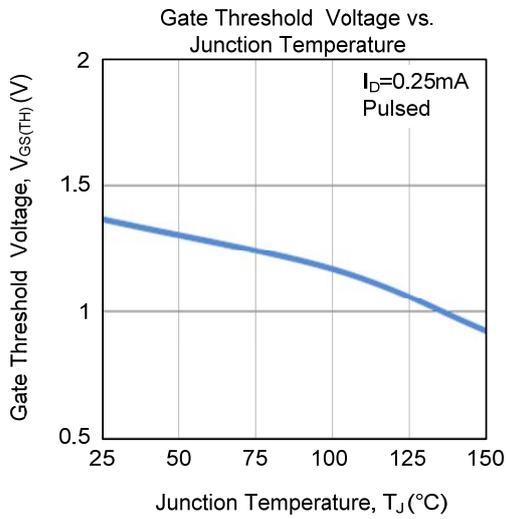
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	30			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =24V, V <sub>GS</sub> =0V			1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1.0		3.0	V
Drain-Source On-State Resistance (Note 2)	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =5.8A			28	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =5.0A			48	mΩ
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =15V, f=1.0MHz		590		pF
Output Capacitance	C <sub>OSS</sub>			270		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			120		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge (Note 2)	Q <sub>G</sub>	V <sub>DS</sub> =24V, V <sub>GS</sub> =10V, I <sub>D</sub> =5.8A		23.5		nC
Gate-Source Charge	Q <sub>GS</sub>			2.7		nC
Gate-Drain Charge	Q <sub>GD</sub>			5.7		nC
Turn-ON Delay Time (Note 2)	t <sub>D(ON)</sub>	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =5.8A, R <sub>G</sub> =3Ω		5		ns
Turn-ON Rise Time	t <sub>R</sub>			16		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>			28		ns
Turn-OFF Fall Time	t <sub>F</sub>			21		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Continuous Drain-Source Diode Forward Current	I <sub>S</sub>				5.8	A
Drain-Source Diode Forward Voltage(Note2)	V <sub>SD</sub>	I <sub>S</sub> =1.0A			1.0	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =5.8A, dI/dt=100A/μs		200		ns
Reverse Recovery Charge	Q <sub>rr</sub>				440	

Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature.  
 2. Pulse width ≤ 300μs, duty cycle ≤ 2%.

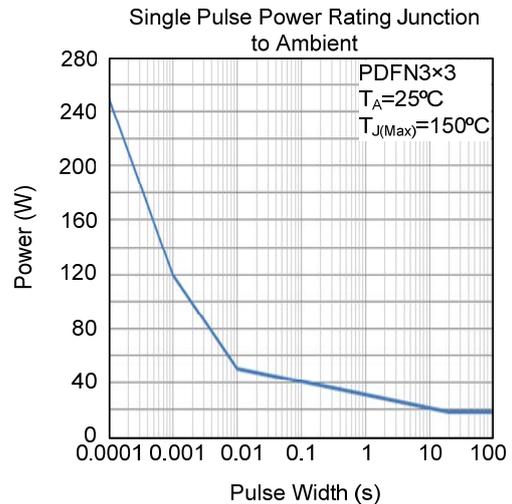
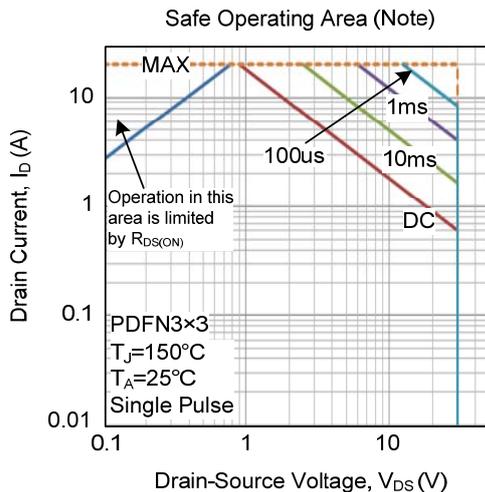
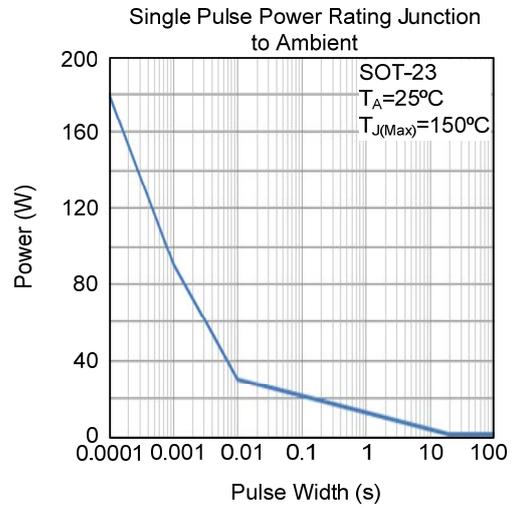
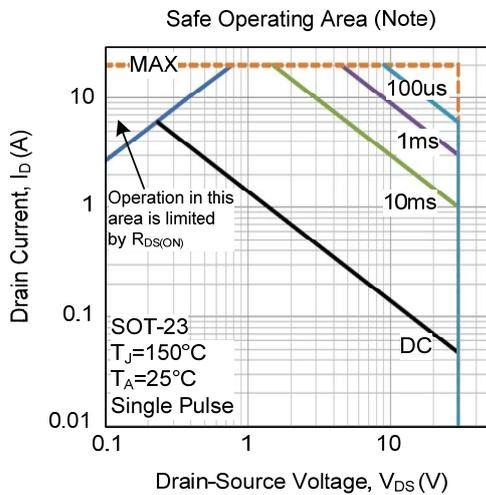
## TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



## ■ TYPICAL CHARACTERISTICS (Cont.)



Note: These tests are performed with the device Mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}\text{C}$ . The SOA curve provides a single pulse rating.

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